

# 3.0 GHz DIVIDE BY 4 PRESCALER

# **UPB1510GV**

### **FEATURES**

• HIGH FREQUENCY OPERATION TO 3 GHz

• FIXED DIVIDE RATIO: ÷ 4

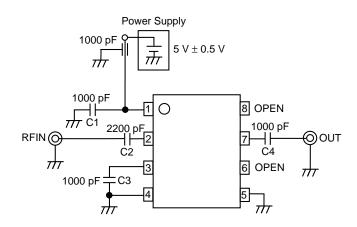
LOW CURRENT CONSUMPTION: 15 mA @ 5 V

SMALL PACKAGE: 8 PIN SSOP
 AVAILABLE IN TAPE AND REEL

#### **DESCRIPTION**

The UPB1510GV is a Silicon MMIC digital prescaler manufactured with the NESAT™ IV silicon bipolar process. It features frequency response to 3 GHz, a divide-by-four ratio, and operates on a 5 volt supply while drawing only 15 mA. The device is housed in a small 8 pin SSOP package that contributes to system miniaturization. The low power consumption and wide frequency operation makes the device well suited for use in a PLL synthesizer for UHF/VHF TV and DBS tuner applications.

#### **TEST CIRCUIT**



### ELECTRICAL CHARACTERISTICS (TA = -40 to +85°C, Vcc = 4.5 to 5.5 V, Zs = ZL = 50 Ω)

PART NUMBER PACKAGE OUTLINE			UPB1510GV S08		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	TYP	MAX
Icc	Circuit Current, No Input Signal	mA		15	
fin (u)1	Upper Limit Operating Frequency 1, PIN = -10 to +6 dBm	GHz	3.0		
fin (u)2	Upper Limit Operating Frequency 2, PIN = -15 to +6 dBm	GHz	2.7		
fin (L)	Lower Limit Operating Frequency, PIN = -15 to +6 dBm	GHz			0.5
Pin1	Input Power 1, fin = 2.7 to 3.0 GHz	dBm	-10		+6
Pin2	Input Power 2, fin = 1.0 to 2.7 GHz	dBm	-15		+6
Роит	Output Power, PIN = 0 dBm, fIN = 2.0 GHz	dBm	-12	-7	

## ABSOLUTE MAXIMUM RATINGS<sup>1</sup> (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
Vcc	Supply Voltage	٧	6.0
Vin	Input Voltage	V	6.0
Po	Total Power Dissipation <sup>2</sup>	mW	250
TA	Operating Ambient Temp.	°C	-40 to +85
Тѕтс	Storage Temperature	°C	-55 to +150

#### Notes:

- Operation in excess of any one of these parameters may result in permanent damage.
- Mounted on a double-sided copper clad 50x50x1.6 mm epoxy glass PWB (TA = +85°C).

# INTERNAL BLOCK DIAGRAM

**RECOMMENDED** 

SYMBOL

Vcc

TΑ

**OPERATING CONDITIONS** 

Supply Voltage

**PARAMETER** 

Operating Ambient Temp.

UNITS

٧

°С

MIN

4.5

-40

TYP

5.0

+25

MAX

5.5

+85

IN O CLK	Q D CLK	Q		
IN O—dCIK			AMP	OUT

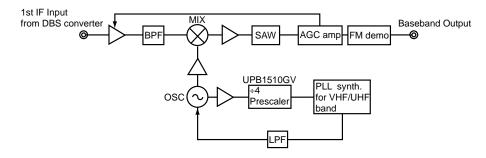
# PRODUCT LINE-UP

Product No.	Icc (mA)	Vcc (V)	÷4 fin (GHz)	Package
UPB585G	18	4.5 to 5.5	0.5 to 2.5	8 pin SOP
UPB1510GV	15	4.5 to 5.5	0.5 to 3.0	8 pin SSOP

Note: This table shows typical values only.

## SYSTEM APPLICATION EXAMPLE

### RF UNIT BLOCK OF DBS TUNER

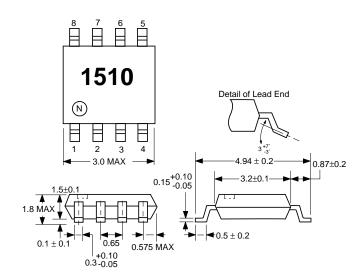


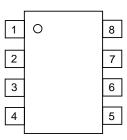
### **PIN DESCRIPTIONS**

Pin No.	Symbol	Applied Voltage	Description
1	vcc	4.5 to 5.5	Power supply pin. This pin must be decoupled with a bypass capacitor (e.g . 1000 pF).
2	IN	-	Signal input pin. This pin should be coupled to source with a capacitor (e.g. 1000 pF).
3	ĪN	-	Signal input bypass pin. This pin must be equipped with a bypass capacitor (e.g. 1000 pF) to ground.
4	GND	0	Ground pin. Ground pattern on the board should be formed as wide as possible to minimize ground impedance.
5	GND	0	
6	NC	_	No connection, this pin should be left open.
7	OUT	-	Divided frequency output pin. This pin is designed as an emitter follower output, and should be coupled to the load with a capacitor (e.g. 1000 pF).
8	NC	_	No connection, this pin should be left open.

## OUTLINE DIMENSIONS (Units in mm)

#### **PACKAGE OUTLINE S08**





#### PIN CONNECTIONS

5. GND
6. NC
7. OUT
8. NC

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### **ORDERING INFORMATION**

PART NUMBER	QUANTITY
UPB1510GV-E1	1000/Reel

#### Note:

Pin 1 is in the tape pull-out direction.

<sup>1.</sup> Embossed tape 8 mm wide.

# **Mouser Electronics**

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NEC:

UPA895TD-T3 UPB1510GV